

IN THE UNITED STATES PATENT AND TRADEMARK OFFICE

41

Applicant: Wing-Cheong G. Lai et al.
Title: SMALL GRAIN SIZE, CONFORMAL ALUMINUM INTERCONNECTS AND METHOD
FOR THEIR FORMATION

Docket No.: 303.261US2
Filed: February 13, 2001
Examiner: Tuan Quach
Customer No.: 21186

Serial No.: 09/782441
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Group Art Unit: 2814
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MS Non-Fee Amendment

Commissioner for Patents
P.O. Box 1450
Alexandria, VA 22313-1450

We are transmitting herewith the following attached items (as indicated with an "X"):

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 An Amendment and Response (10 Pages).

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SCHWEGMAN, LUNDBERG, WOESSNER & KLUTH, P.A.
Customer Number 21186

By: J. M. Kalis
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CERTIFICATE UNDER 37 CFR 1.8: The undersigned hereby certifies that this correspondence is being deposited with the United States Postal Service with sufficient postage as first class mail, in an envelope addressed to: MS Non-Fee Amendment, Commissioner for Patents, P.O.Box 1450, Alexandria, VA 22313-1450, on this 22 day of September, 2003.

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